PCI	N Nu	mber:	2020	001280	007		PCN Date:	Ja	n. 3	31, 202	0	
Title: Datasheet for TPS57112C-Q1												
Customer Contact:			PCN Manager						Dep	ot:	Quality Services	
Change Type:												
		embly Site		•		Design				Wafer	Bump Site	
		embly Process			\boxtimes						Bump Material	
		embly Material				Part numbe	r change				Bump Process	
Mechanical Specifica					Щ	Test Site			Щ		Fab Site	
	Packing/Shipping/Labelin			ng		Test Proces	S				Fab Materials	
							.			Wafer	Fab Process	
Notification Details												
Description of Change:												
Texas Instruments Incorporated is announcing an information only notification.												
The product datasheet(s) is being updated as summarized below.												
The following change history provides further details.												
TEXAS TPS57112C-Q1												
SLVSDU5A – APRIL 2018 – REVISED NOVEMBER 2019												
Changes from Original (April 2018) to Revision A Page												
First public release of data sheet												
The datasheet number will be changing.												
Device Family							Change From:			Change To:		
TP	TPS57112C-Q1					SLVS	SLVSDU5			SLVSDU5A		
These changes may be reviewed at the datasheet links provided.												
http://www.ti.com/product/TPS57112C-Q1												
Reason for Change:												
To accurately reflect device characteristics.												
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):												
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.												
Changes to product identification resulting from this PCN:												
None.												
Pro	duct	: Affected:										
TP	S571	12CORTERO1										

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN_ww_admin_team@list.ti.com

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